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October 2013

FQB34N20L N-Channel QFET® MOSFET

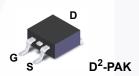
200 V, 31 A, 75 mΩ

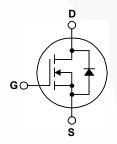
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 31 A, 200 V, $R_{DS(on)} = 75 \text{ m}\Omega \text{ (max.)} @ V_{GS} = 10 \text{ V}, I_D = 15.5 \text{ A}$
- Low Gate Charge (Typ. 55 nC)
- Low Crss (Typ. 52 pF)
- 100% Avalanche Tested
- Low level gate drive requirement allowing direct opration from logic drivers
- · RoHS Compliant





Absolute Maximum Ratings $T_C = 25$ °C unless otherwise noted

Symbol	Parameter		FQB34N20LTM	Unit		
V_{DSS}	Drain-Source Voltage		200	V		
I _D	Drain Current - Continuous (T _C = 25°C)		31	А		
	- Continuous (T _C = 100°C))	20	А		
I _{DM}	Drain Current - Pulsed	(Note 1)	124	А		
V _{GSS}	Gate-Source Voltage		± 20	V		
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		Single Pulsed Avalanche Energy (Note 2) 640		640	mJ
I _{AR}	Avalanche Current	(Note 1)	31	А		
E _{AR}	Repetitive Avalanche Energy	(Note 1)	18	mJ		
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns		
P_{D}	Power Dissipation (T _A = 25°C) *		3.13	W		
	Power Dissipation (T _C = 25°C)		180	W		
	- Derate above 25°C		1.43	W/°C		
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C		
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C		

Thermal Characteristics

Symbol	Parameter	FQB34N20LTM	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.7	
В	Thermal Resistance, Junction to Ambient (minimum pad of 2 oz copper), Max.	62.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (* 1 in² pad of 2 oz copper), Max.	40	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FQB34N20L	FQB34N20LTM	D2-PAK	330mm	24mm	800

Electrical Characteristics $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.16		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 200 V, V _{GS} = 0 V			1	μΑ
	Zero Gate voltage Drain Current	V _{DS} = 160 V, T _C = 125°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -20 V, V _{DS} = 0 V			-100	nA

On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0		2.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 15.5 \text{ A}$ $V_{GS} = 5 \text{ V}, I_D = 15.5 \text{ A}$	1	0.057 0.060	0.075 0.080	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 30 \text{ V}, I_{D} = 15.5 \text{ A}$		41		S

Dynamic Characteristics

C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$	 3000	3900	pF
C _{oss}	Output Capacitance	f = 1.0 MHz	 400	520	pF
C _{rss}	Reverse Transfer Capacitance		 52	67	pF

Switching Characteristics

t _{d(on)}	Turn-On Delay Time	V _{DD} = 100 V, I _D = 34 A,			45	100	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$			520	1050	ns
t _{d(off)}	Turn-Off Delay Time				170	350	ns
t _f	Turn-Off Fall Time		(Note 4)	/	370	750	ns
Q_g	Total Gate Charge	V _{DS} = 160 V, I _D = 34 A,			55	72	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 5 V		/	9.9		nC
Q _{gd}	Gate-Drain Charge		(Note 4)		27		nC

Drain-Source Diode Characteristics and Maximum Ratings

IS	Maximum Continuous Drain-Source Diode Forward Current		 	31	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		 	124	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 31 A	 	1.5	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 34 A,	 205		ns
Q _{rr}	Reverse Recovery Charge	$dI_F / dt = 100 A/\mu s$	 1.1	\	μC

- **Notes:** 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 1.0mH, $I_{AS} = 31A$, $V_{DD} = 50V$, $R_{G} = 25 \Omega$, Starting $T_{J} = 25^{\circ}C$ 3. $I_{SD} \le 34A$, $di/dt \le 300A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_{J} = 25^{\circ}C$ 4. Essentially independent of operating temperature

Typical Characteristics

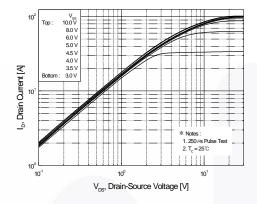


Figure 1. On-Region Characteristics

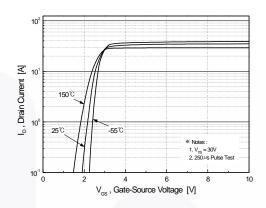


Figure 2. Transfer Characteristics

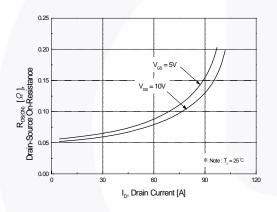


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

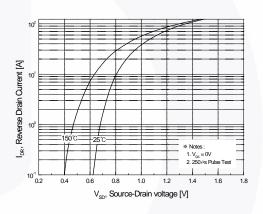


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

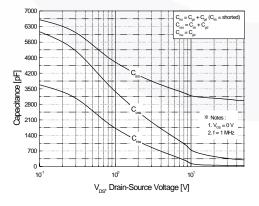


Figure 5. Capacitance Characteristics

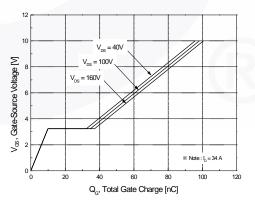


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

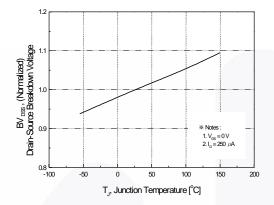


Figure 7. Breakdown Voltage Variation vs. Temperature

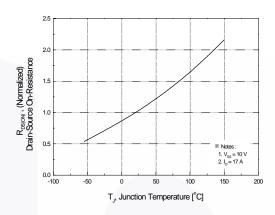


Figure 8. On-Resistance Variation vs. Temperature

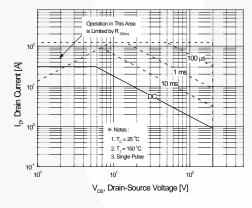


Figure 9. Maximum Safe Operating Area

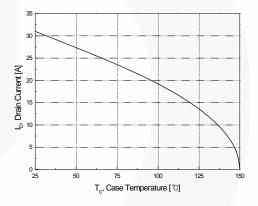


Figure 10. Maximum Drain Current vs. Case Temperature

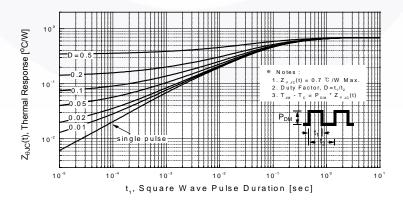


Figure 11. Transient Thermal Response Curve



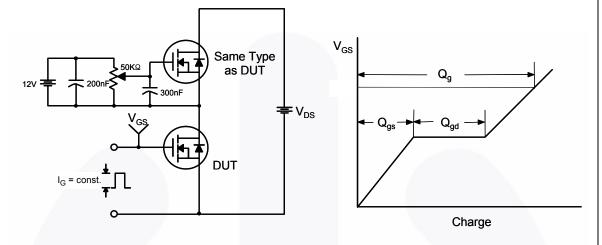


Figure 13. Resistive Switching Test Circuit & Waveforms

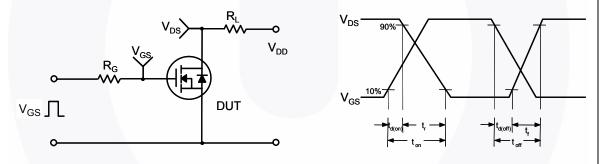
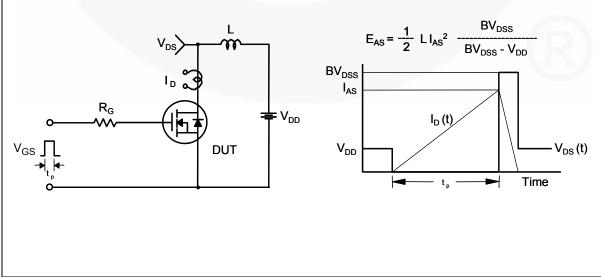
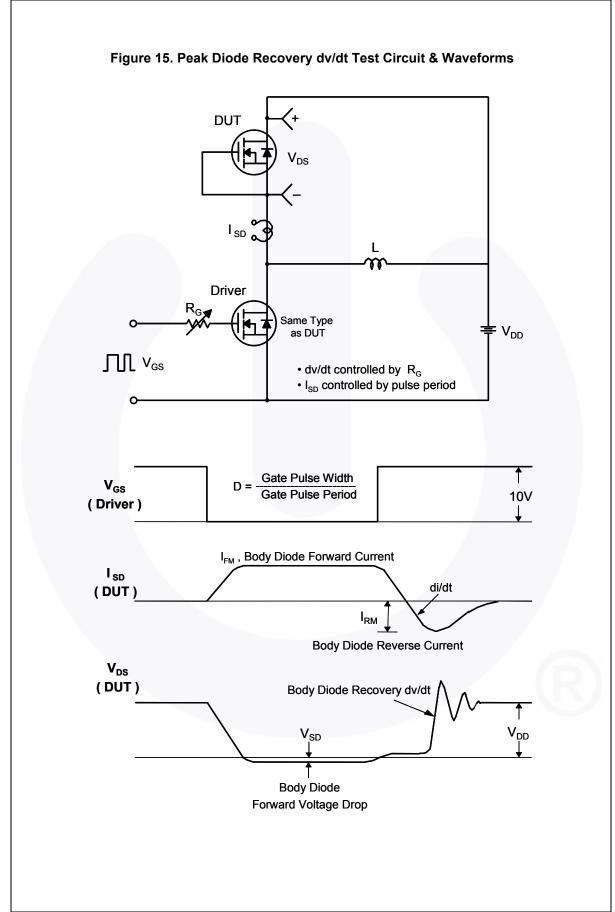


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms





Mechanical Dimensions

TO-263 2L (D²PAK)

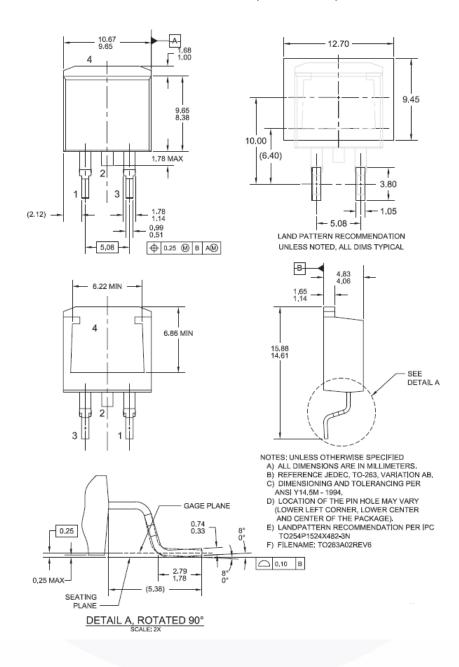


Figure 16. 2LD, TO263, Surface Mount

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Dimension in Millimeters

FQB34N20L Rev. C1





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